

G3VM-21PR10

MOS FET Relays

Smallest Class in market, USOP Package MOS FET Relays with Low Output Capacitance and ON Resistance ($C_xR=2.5\text{pF}\cdot\Omega$)

• Dielectric strength of 500Vrms between I/O.



NEW

Note: The actual product is marked differently from the image shown here.

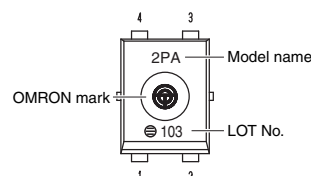
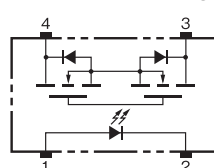
RoHS Compliant

Refer to "Common Precautions".

Application Examples

- Semiconductor test equipment
- Communication equipment
- Test & measurement equipment
- Data loggers

Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

List of Models

Package type	Contact form	Terminals	Load voltage (peak value) (See note.)	Model	Minimum package quantity
					Number per tape & reel
USOP4	1a (SPST-NO)	Surface-mounting terminals	20V	G3VM-21PR10	—
				G3VM-21PR10 (TR05)	500
				G3VM-21PR10 (TR)	1,500

Note 1. Ask your OMRON representative for orders under 1,500 pcs or 500 pcs.

2. Tape-cut USOPs are packaged without humidity resistance. Use manual soldering to mount them. Refer to common precautions.

3. The AC peak and DC value is given for the load voltages.

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

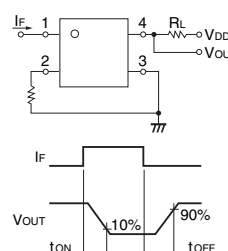
Item	Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	I_F	50	mA
	LED forward current reduction rate	$\Delta I_F/^\circ\text{C}$	-0.5	$\text{mA}/^\circ\text{C}$
	LED reverse voltage	V_R	5	V
	Connection temperature	T_J	125	$^\circ\text{C}$
Output	Load voltage (AC peak/DC)	V_{OFF}	20	V
	Continuous load current (AC peak/DC)	I_O	200	mA
	ON current reduction rate	$\Delta I_O/^\circ\text{C}$	-2.0	$\text{mA}/^\circ\text{C}$
	Pulse ON current	I_{OP}	600	mA
	Connection temperature	T_J	125	$^\circ\text{C}$
Dielectric strength between I/O (See note 1.)		V_{I-O}	500	Vrms
Ambient operating temperature		T_a	-40~+85	$^\circ\text{C}$
Ambient storage temperature		T_{STG}	-40~+125	$^\circ\text{C}$
Soldering temperature		—	260	$^\circ\text{C}$

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	V _F	1.0	1.15	1.3	V	I _F =10mA
	Reverse current	I _R	—	—	10	μA	V _R =5V
	Capacity between terminals	C _T	—	15	—	pF	V=0, f=1MHz
	Trigger LED forward current	I _{FT}	—	1.0	3	mA	I _O =100mA
Output	Maximum resistance with output ON	R _{ON}	—	3	5	Ω	I _F =5mA, I _O =200mA, t<1s
	Current leakage when the relay is open	I _{LEAK}	—	—	1	nA	V _{OFF} =20V, T _a =25°C
	Capacity between terminals	C _{OFF}	—	0.8	1.1	pF	V=0, f=100MHz, t<1s
	Capacity between I/O terminals	C _{I-O}	—	0.4	—	pF	f=1MHz, V _S =0V
Insulation resistance between I/O terminals		R _{I-O}	1000	—	—	MΩ	V _{I-O} =500VDC, R _{oH} ≤60%
Turn-ON time		t _{ON}	—	0.04	0.2	ms	I _F =5mA, R _L =200Ω, V _{DD} =10V (See note 2.)
Turn-OFF time		t _{OFF}	—	0.13	0.2	ms	

Note: 2. Turn-ON and Turn-OFF Times



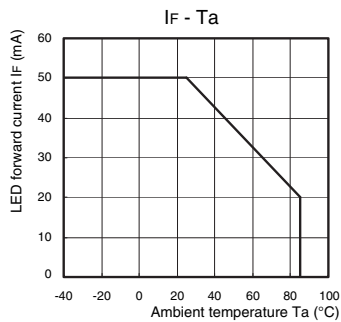
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

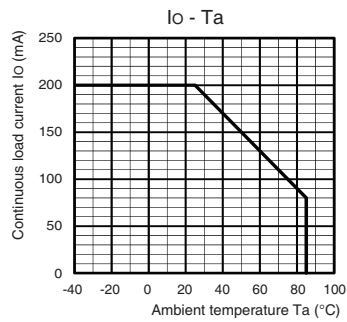
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	–	–	16	V
Operating LED forward current	I_F	5	7.5	20	mA
Continuous load current (AC peak/DC)	I_O	–	–	200	mA
Ambient operating temperature	T_a	–20	–	65	°C

Engineering Data

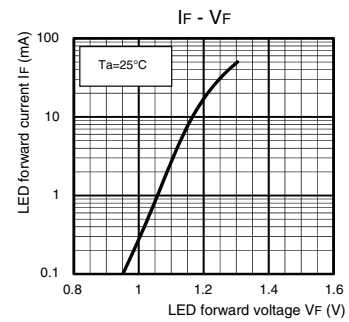
LED forward current vs. Ambient temperature



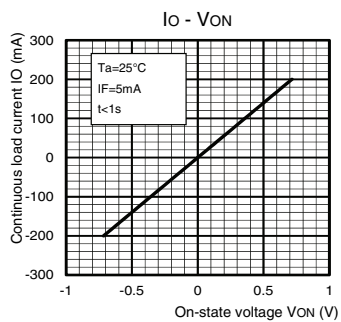
Continuous load current vs. Ambient temperature



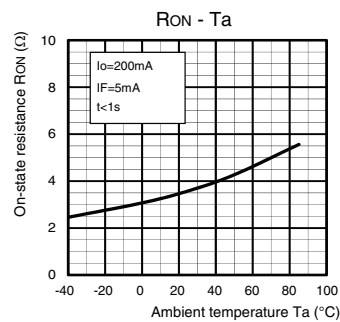
LED forward current vs. LED forward voltage



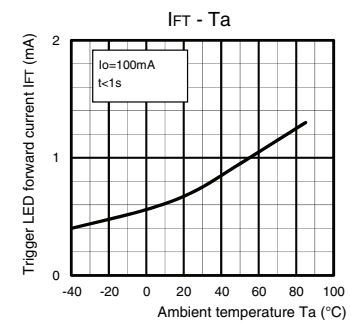
Continuous load current vs. On-state voltage



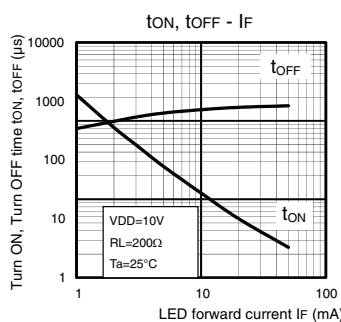
On-state resistance vs. Ambient temperature



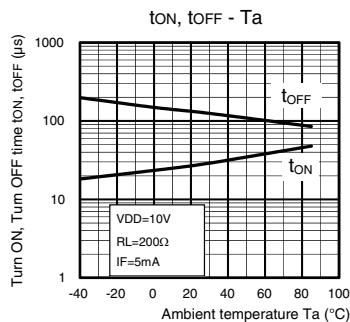
Trigger LED forward current vs. Ambient temperature



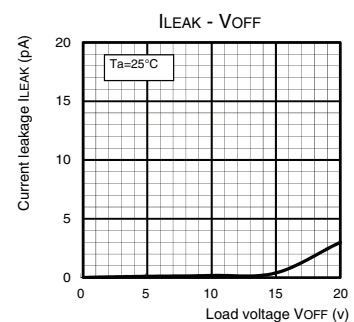
Turn ON, Turn OFF time vs. LED forward current



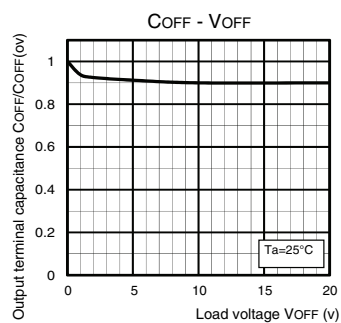
Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Load voltage



Output terminal capacitance COFF/COFF(ov) vs. Load voltage

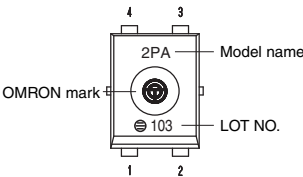


Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■Appearance

USOP (Ultra Small Outline Package)
USOP4



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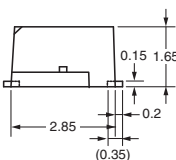
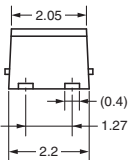
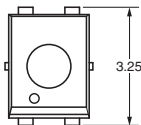
■Dimensions

(Unit: mm)



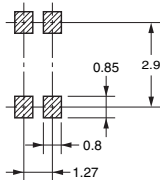
Surface-mounting Terminals

Weight: 0.03g



Actual Mounting Pad Dimensions

(Recommended Value, Top View)



Note: The actual product is marked differently from the image shown here.

- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

Cat. No. **K195-E1-02**
1112(0912)(O)

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